



ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	PART	SYMBOL	VALUE	UNIT
INPUT					
Reverse voltage			V _R	6	V
Forward current			I _F	60	mA
Power dissipation			P _{diss}	100	mW
Derate from 25 °C				1.33	mW/°C
OUTPUT					
Peak off-state voltage		VO4256D/H/M	V _{DRM}	600	V
RMS on-state current			I _{TM}	300	mA
Power dissipation			P _{diss}	500	mW
Derate from 25 °C				6.6	mW/°C
COUPLER					
Storage temperature range			T _{stg}	-55 to +150	°C
Ambient temperature range			T _{amb}	-55 to +100	°C
Soldering temperature	Max. ≤ 10 s dip soldering ≥ 0.5 mm from case bottom		T _{slid}	260	°C

Note

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.

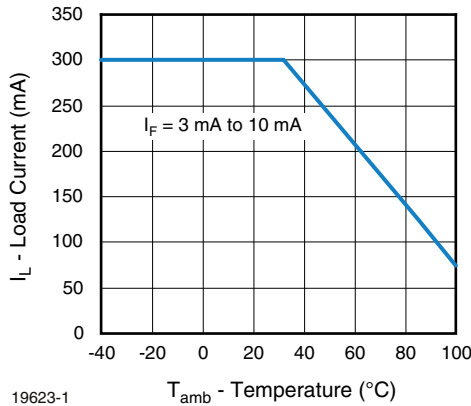


Fig. 1 - Recommended Operating Condition

SAFETY AND INSULATION RATINGS				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Climatic classification	According to IEC 68 part 1		55 / 100 / 21	
Pollution degree	According to DIN VDE 0109		2	
Comparative tracking index	Insulation group IIIa	CTI	175	
Maximum rated withstanding isolation voltage	According to UL1577, t = 1 min	V_{ISO}	4420	V_{RMS}
Maximum transient isolation voltage	According to DIN EN 60747-5-5	V_{IOTM}	8000	V_{peak}
Maximum repetitive peak isolation voltage	According to DIN EN 60747-5-5	V_{IORM}	890	V_{peak}
Isolation resistance	$T_{amb} = 25\text{ }^{\circ}\text{C}$, $V_{IO} = 500\text{ V}$	R_{IO}	$\geq 10^{12}$	Ω
	$T_{amb} = 100\text{ }^{\circ}\text{C}$, $V_{IO} = 500\text{ V}$	R_{IO}	$\geq 10^{11}$	Ω
Output safety power		P_{SO}	500	mW
Input safety current		I_{SI}	250	mA
Input safety temperature		T_S	175	$^{\circ}\text{C}$
Creepage distance	DIP-6		≥ 7	mm
Clearance distance			≥ 7	mm
Creepage distance	DIP-6, 400 mil, option 6		≥ 8	mm
Clearance distance			≥ 8	mm
Creepage distance	SMD-6, option 7		≥ 7	mm
Clearance distance			≥ 7	mm
Insulation thickness		DTI	≥ 0.4	mm

Note

- As per IEC 60747-5-5, § 7.4.3.8.2, this optocoupler is suitable for “safe electrical insulation” only within the safety ratings. Compliance with the safety ratings shall be ensured by means of protective circuits.

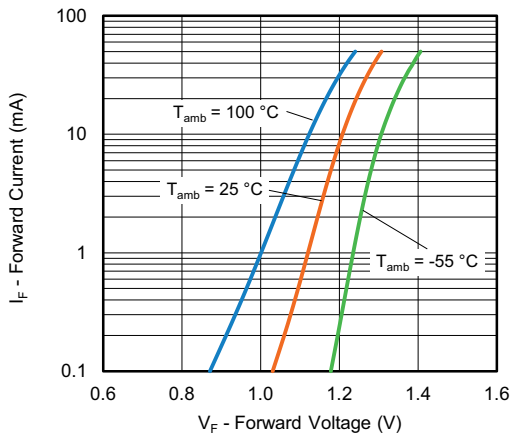
TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)


Fig. 2 - Diode Forward Voltage vs. Forward Current

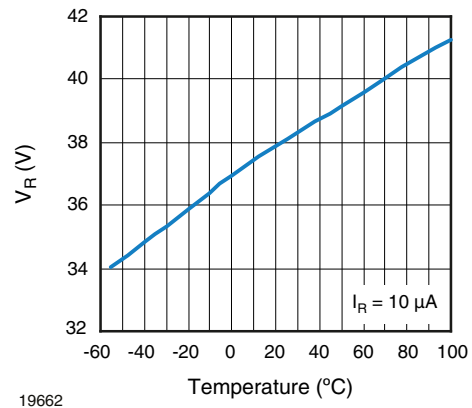


Fig. 3 - Diode Reverse Voltage vs. Temperature

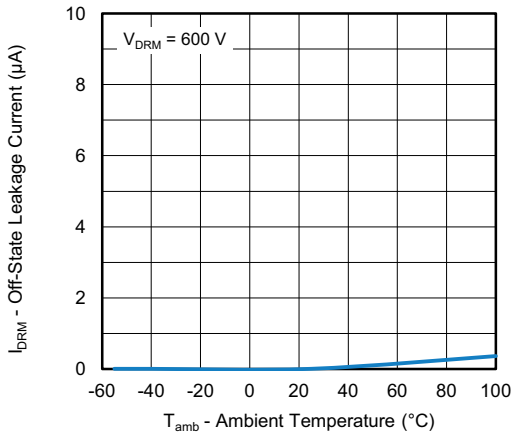


Fig. 4 - Leakage Current vs. Ambient Temperature

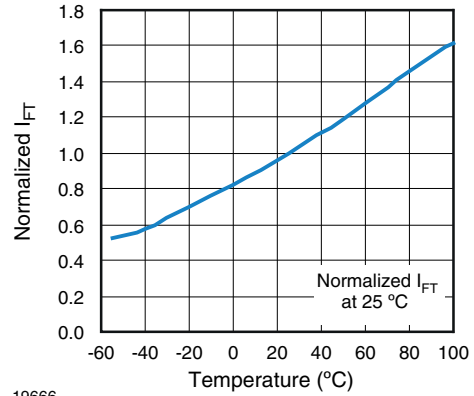


Fig. 7 - Normalized Trigger Input Current vs. Temperature

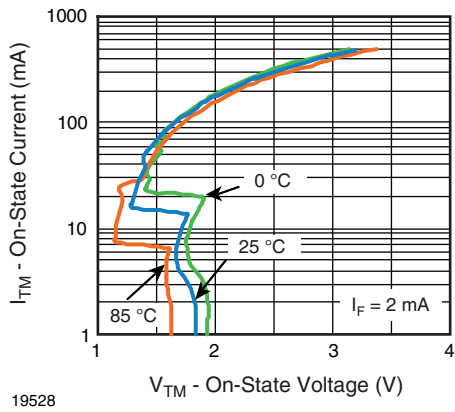


Fig. 5 - On-State Current vs. On-State Voltage

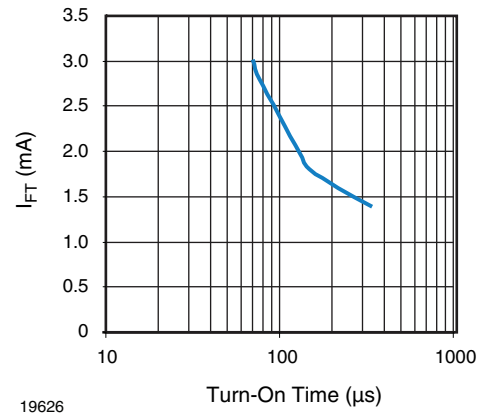


Fig. 8 - I_{FT} vs. Turn-On Time (μ s)

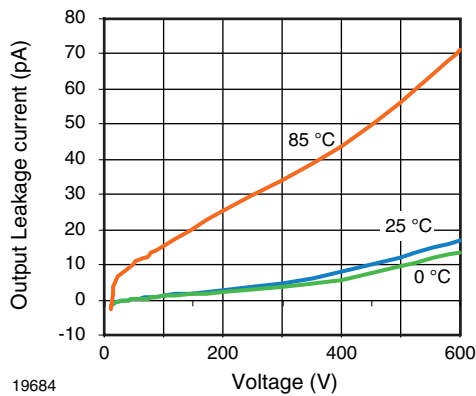


Fig. 6 - Output Off Current (Leakage) vs. Voltage

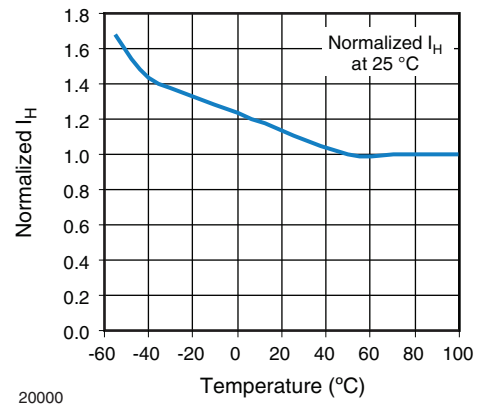


Fig. 9 - Normalized I_H vs. Temperature

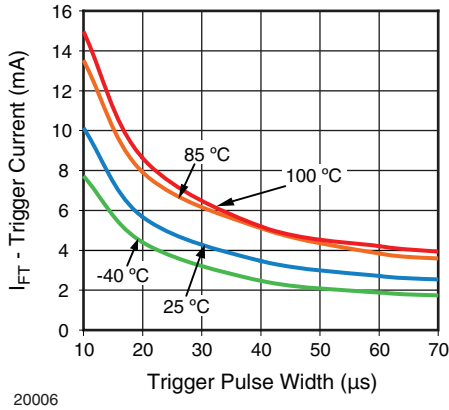
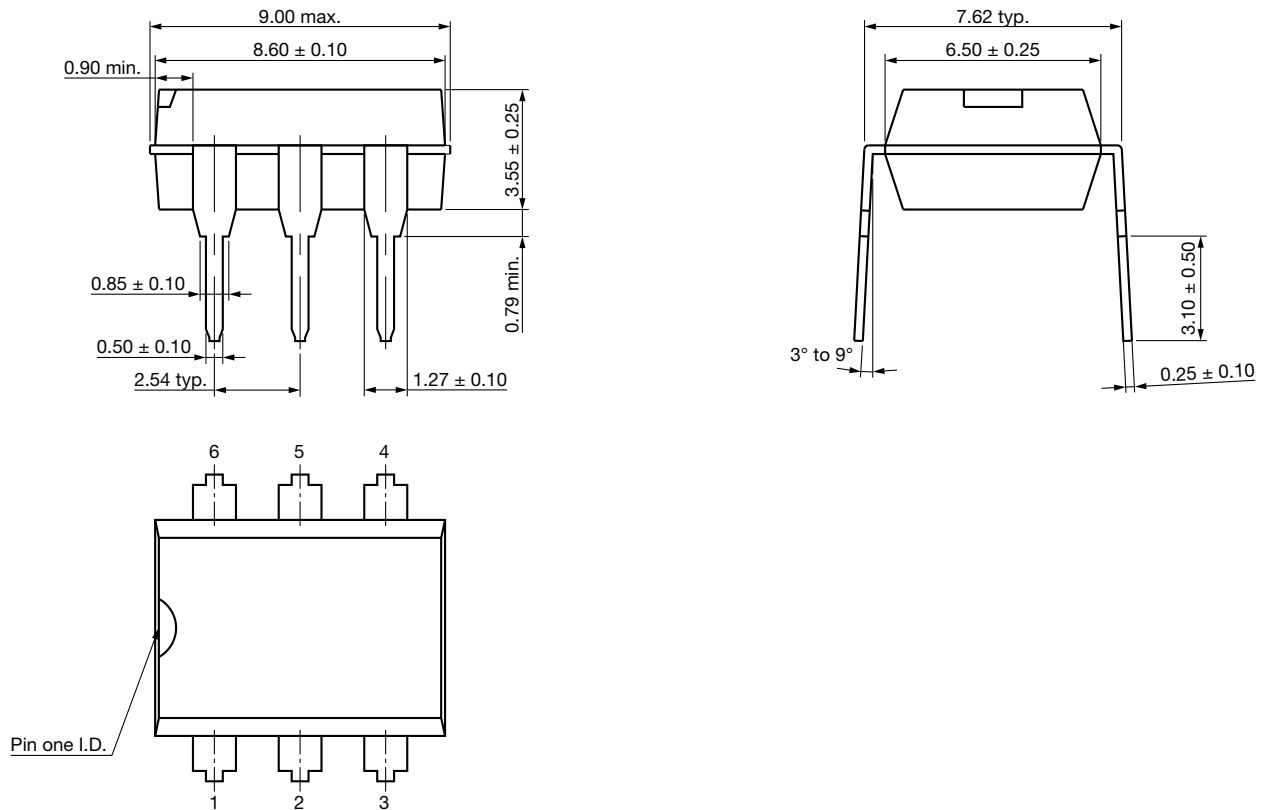


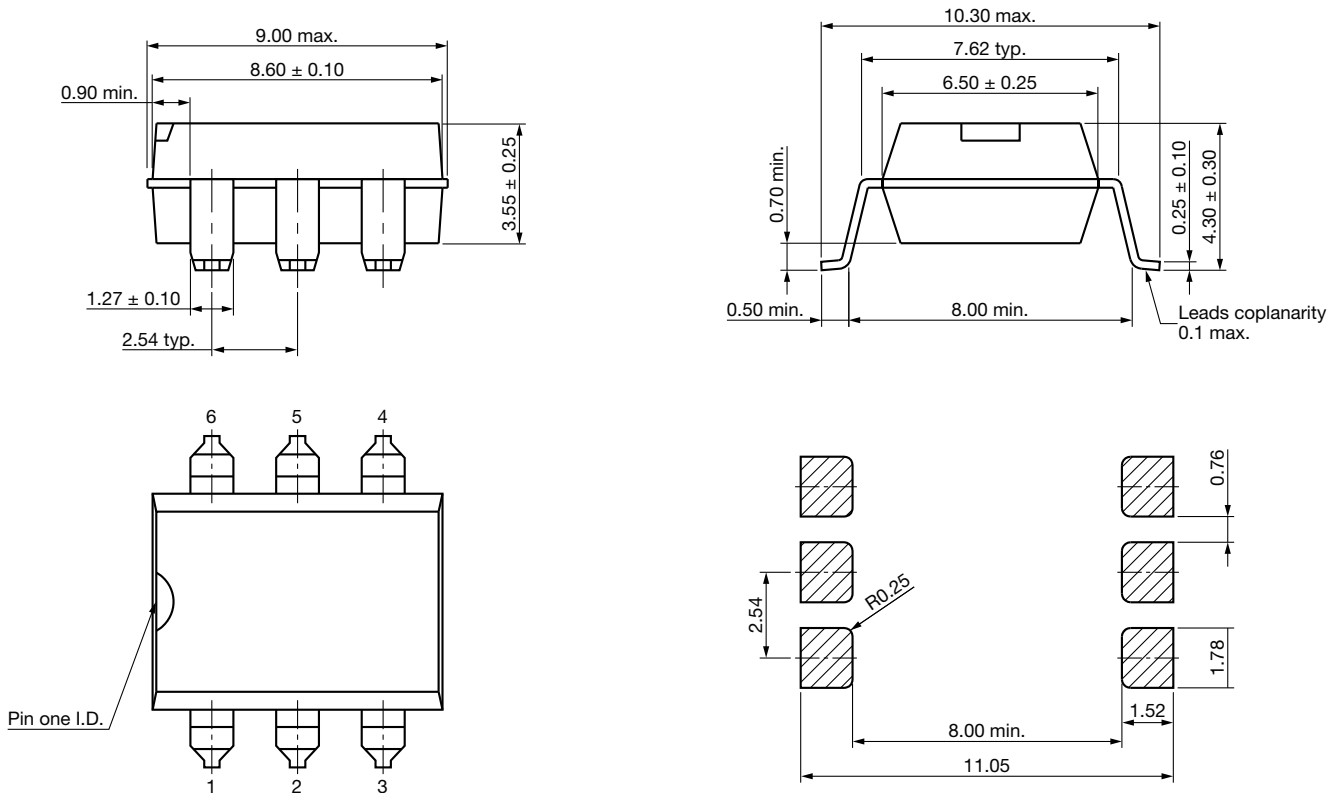
Fig. 10 - I_{FT} vs. LED Pulse Width

PACKAGE DIMENSIONS (in millimeters)

DIP-6



SMD-6, Option 7



PACKAGE MARKING

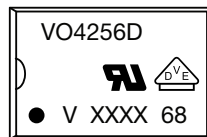


Fig. 11 - Example of VO4256D-X001

Notes

- XXXX = LMC (lot marking code)
- The VDE logo is only marked on option 1 parts
- Tape and reel suffix (T) is not part of the package marking

PACKING INFORMATION (in millimeters)

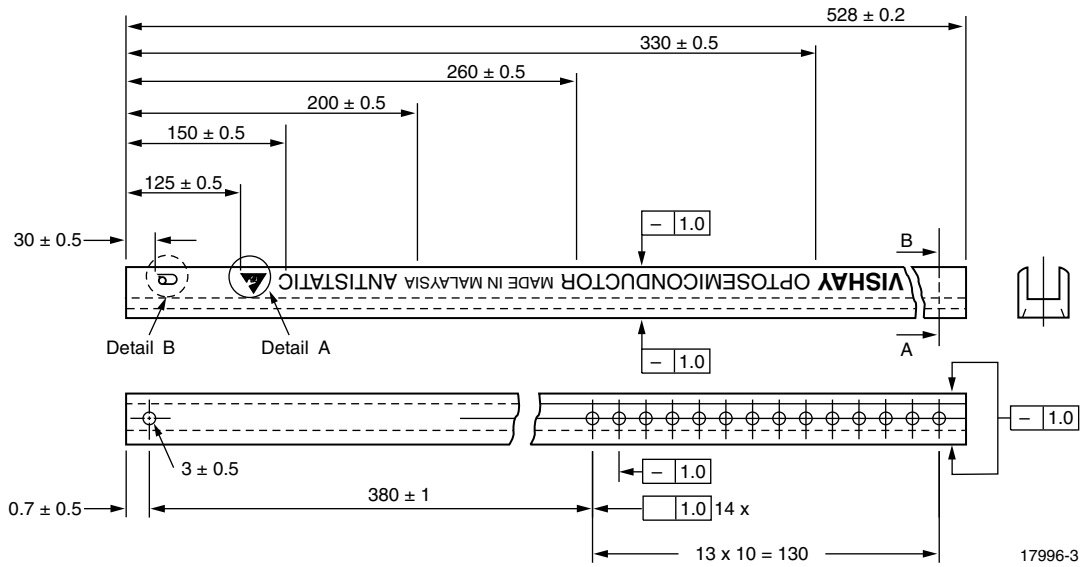
Tube


Fig. 12 - Shipping Tube Specifications for DIP-6 Packages

DEVICES PER TUBS			
TYPE	UNITS/TUBE	TUBES/BOX	UNITS/BOX
DIP-6	50	40	2000

DIP-6

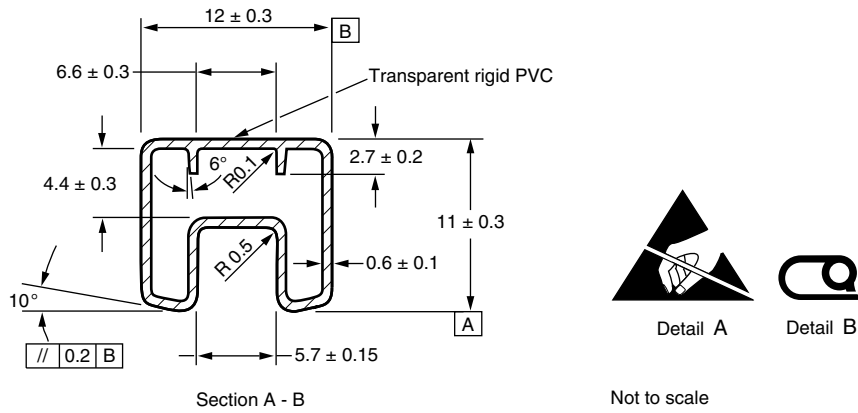


Fig. 13 - Tube Shipping Medium

DIP-6, Option 6

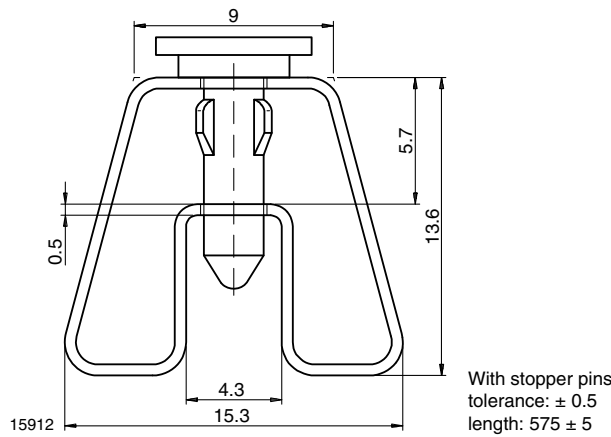


Fig. 14 - Tube Shipping Medium

Tape and Reel

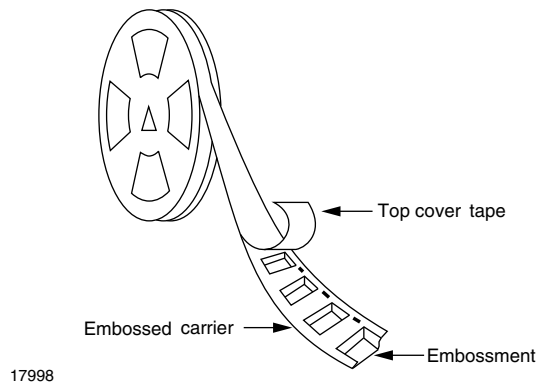


Fig. 15 - Tape and Reel Shipping Medium

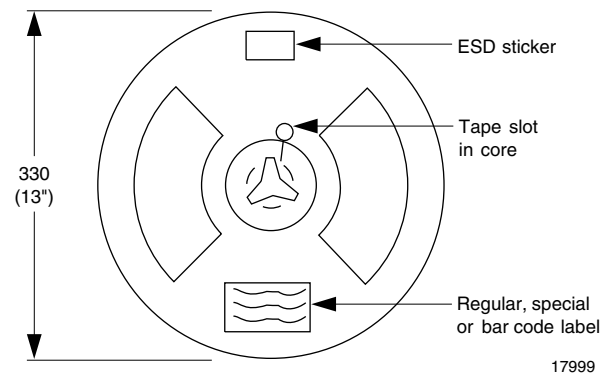


Fig. 16 - Tape and Reel Shipping Medium

SMD-6, Option 7

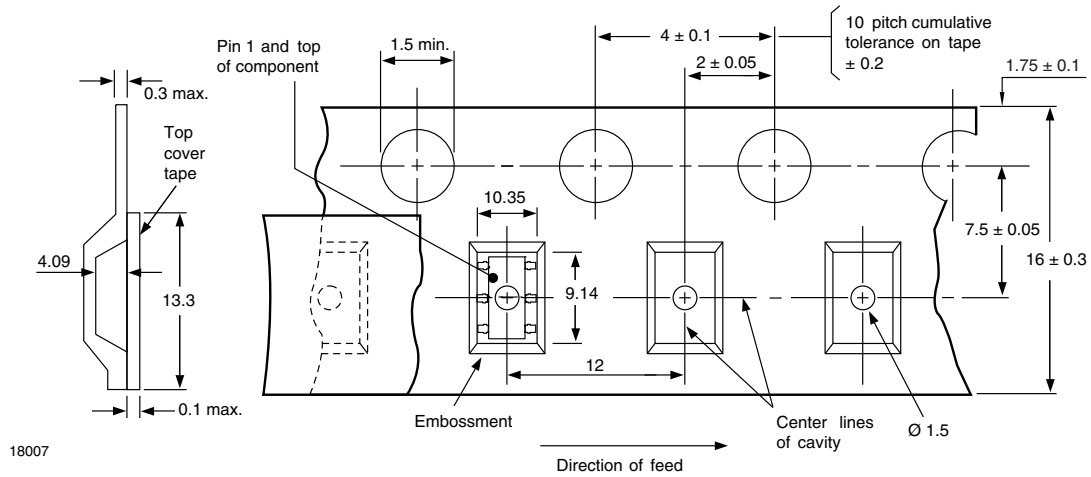
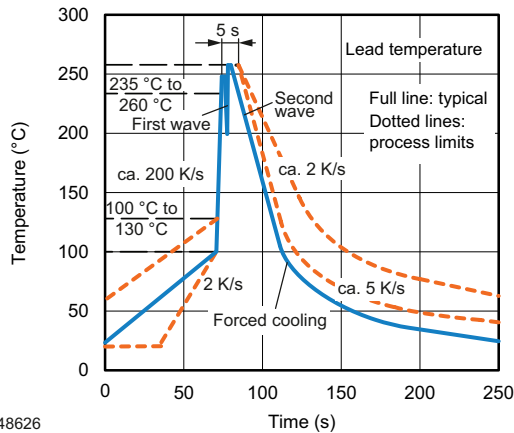


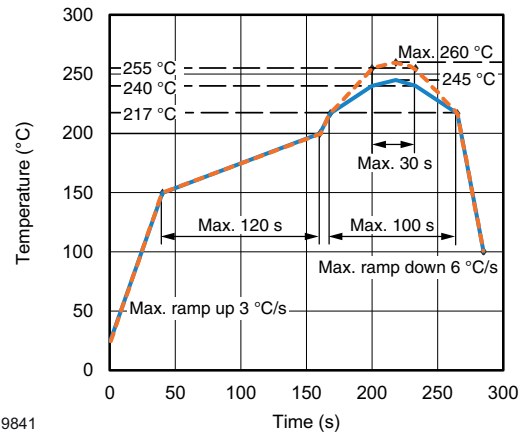
Fig. 17 - Tape and Reel Packing (1000 pieces on Reel)

SOLDER PROFILES



948626

Fig. 18 - Wave Soldering Double Wave Profile According to J-STD-020 for DIP Devices



19841

Fig. 19 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020 for SMD Devices

HANDLING AND STORAGE CONDITIONS

ESD level: HBM class 2

Floor life: unlimited

Conditions: $T_{amb} < 30\text{ }^{\circ}\text{C}$, RH < 85 %

Moisture sensitivity level 1, according to J-STD-020



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